TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

TCR2EF series TCR2EE series

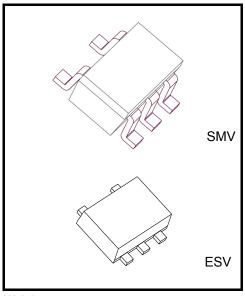
200 mA CMOS Low Drop-Out Regulator with Fast Load Transient Response

The TCR2EF and TCR2EF series are CMOS single-output voltage regulators with an on/off control input, featuring low dropout voltage, low output noise voltage and fast load transient response.

These voltage regulators are available in fixed output voltages between 1.0 V and 5.0 V and capable of driving up to 200 mA. They feature overcurrent protection, an Auto-discharge function.

The TCR2EF and TCR2EE series has a low dropout voltage of 180 mV (2.5 V output, I_{OUT} = 150 mA) with low output noise voltage of 35 μV_{rms} (2.5 V output) and a load transient response of only \triangle V_{OUT} = ± 60 mV (I_{OUT} = 1 mA \Leftrightarrow 150 mA, C_{OUT} =1.0 μF).

Thus, the TCR2EF and TCR2EE series are suitable for sensitive power supply such as Analog and RF applications.



Weight: SMV (SOT-25)(SC-74A): 16 mg (typ.) ESV (SOT-553): 3.0 mg (typ.)

Features

Low Drop-Out voltage

 $V_{IN}-V_{OUT}$ = 150 mV (typ.) at 3.0 V-output, I_{OUT} = 150 mA

 $V_{IN}-V_{OUT}$ = 180 mV (typ.) at 2.5 V-output, I_{OUT} = 150 mA

 V_{IN} - V_{OUT} = 230 mV (typ.) at 1.8 V-output, I_{OUT} = 150 mA

 V_{IN} - V_{OUT} = 380 mV (typ.) at 1.2 V-output, I_{OUT} = 150 mA

 V_{IN} - V_{OUT} = 510 mV (typ.) at 1.0 V-output, I_{OUT} = 150 mA

- Low output noise voltage (V_{NO} = 35 μV_{rms} (typ.) at 2.5 V-output, I_{OUT} = 10 mA, 10 Hz < f < 100 kHz)
- Fast load transient response (\angle IV_{OUT} = \pm 60 mV (typ.) at I_{OUT} = 1 mA \Leftrightarrow 150 mA, C_{OUT} =1.0 μ F)
- Low quiescent bias current (I_B = 35 μA (typ.) at I_{OUT} = 0 mA)
- High ripple rejection (R.R = 73 dB (typ.) at 2.5V-output, I_{OUT} = 10 mA, f = 1kHz)
- Wide range Output Voltage line up (V_{OUT} = 1.0 to 5.0 V)
- High V_{OUT} accuracy $\pm 1.0\%$ ($1.8V \le V_{OUT}$)
- Overcurrent protection
- Auto-discharge
- Pull down connection between CONTROL and GND
- Ceramic capacitors can be used (C_{IN} = 0.1 μ F, C_{OUT} =1.0 μ F)
- Small package ESV(SOT-553) (1.6 mm x 1.6 mm x 0.55 mm)
 General package SMV(SOT-25) (2.8 mm x 2.9 mm x 1.1 mm)



Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating			Unit
Input voltage	V _{IN}	6.0			V
Control voltage	V _{CT}	-0.3 to 6.0			V
Output voltage	V _{OUT}	-0.3 to V _{IN} + 0.3			V
Output current	lout	200			mA
Power dissipation		CM)/	200	(Note1)	
	P _D	SMV	580	(Note 2)	mW
		۲۵	F0)/	150	(Note 1)
		ESV	320	(Note 3)	
Operation temperature range	T _{opr}	-40 to 85			°C
Junction temperature	Tj	150			°C
Storage temperature range	T _{stg}	-55 to 150			°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Unit Rating

Note 2: Rating at mounting on a board

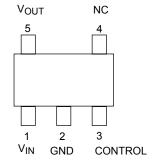
(FR4 board: 25.4 mm \times 25.4 mm \times 1.6 mm)

Note 3: Rating at mounting on a board

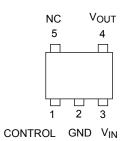
(FR4 board dimension: 30 mm \times 30 mm \times 0.8 mm)

Pin Assignment (top view)

SMV(SOT-25)(SC-74A)



ESV(SOT-553)





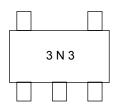
List of Products Number, Output voltage and Marking

Produ	ıct No.	V _{OUT}	Marking	Product No.		V _{OUT}	Marking
SMV(SOT-25)	ESV(SOT-553)	(V)(typ.)		SMV(SOT-25)	ESV(SOT-553)	(V)(typ.)	
TCR2EF10	TCR2EE10	1.0	1N0	TCR2EF24*	TCR2EE24*	2.4	2N4
TCR2EF105*	TCR2EE105*	1.05	1NA	TCR2EF25	TCR2EE25	2.5	2N5
TCR2EF11	TCR2EE11	1.1	1N1	TCR2EF26*	TCR2EE26*	2.6	2N6
TCR2EF115*	TCR2EE115	1.15	1NB	TCR2EF27*	TCR2EE27*	2.7	2N7
TCR2EF12	TCR2EE12	1.2	1N2	TCR2EF28	TCR2EE28	2.8	2N8
TCR2EF125*	TCR2EE125*	1.25	1NC	TCR2EF285*	TCR2EE285*	2.85	2ND
TCR2EF13	TCR2EE13	1.3	1N3	TCR2EF29*	TCR2EE29*	2.9	2N9
TCR2EF135*	TCR2EE135	1.35	1ND	TCR2EF295*	TCR2EE295*	2.95	2NE
TCR2EF14*	TCR2EE14*	1.4	1N4	TCR2EF30	TCR2EE30	3.0	3N0
TCR2EF15	TCR2EE15	1.5	1N5	TCR2EF31	TCR2EE31*	3.1	3N1
TCR2EF16*	TCR2EE16*	1.6	1N6	TCR2EF32*	TCR2EE32*	3.2	3N2
TCR2EF17*	TCR2EE17*	1.7	1N7	TCR2EF33	TCR2EE33	3.3	3N3
TCR2EF18	TCR2EE18	1.8	1N8	TCR2EF34*	TCR2EE34*	3.4	3N4
TCR2EF19*	TCR2EE19*	1.9	1N9	TCR2EF35*	TCR2EE35*	3.5	3N5
TCR2EF20*	TCR2EE20*	2.0	2N0	TCR2EF36*	TCR2EE36*	3.6	3N6
TCR2EF21*	TCR2EE21*	2.1	2N1	TCR2EF41	TCR2EE41*	4.1	4N1
TCR2EF22*	TCR2EE22*	2.2	2N2	TCR2EF45	TCR2EE45	4.5	4N5
TCR2EF23*	TCR2EE23*	2.3	2N3	TCR2EF50	TCR2EE50	5.0	5N0

Please contact your local Toshiba representative if you are interested in products with * sign

Marking (top view)

Example: TCR2EF33 (3.3 V output) Example: TCR2EE33 (3.3 V output)





3

Electrical Characteristics

(Unless otherwise specified,

 $V_{IN} = V_{OUT} + 1$ V, $I_{OUT} = 50$ mA, $C_{IN} = 0.1$ μF , $C_{OUT} = 1.0$ μF , $T_i = 25$ °C)

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Output voltage accuracy	V _{OUT}	I _{OUT} = 50 mA (Note 4)	V _{OUT} <1.8 V	-18	_	+18	mV
Output voltage accuracy	V001	1001 = 20 HIA (Note 4)	1.8V ≦V _{OUT}	-1.0	_	+1.0	%
Input voltage	V _{IN}	I _{OUT} = 1 mA		1.5	_	5.5	V
Line regulation	Reg·line	V_{OUT} + 0.5 V \leq V _{IN} \leq 5.5 V, I_{OUT} = 1 mA		_	1	15	mV
Load regulation	Reg·load	1 mA ≤ I _{OUT} ≤ 150 mA		_	15	30	mV
Quiescent current	ΙΒ	I _{OUT} = 0 mA		_	35	60	μА
Stand-by current	I _{B (OFF)}	V _{CT} = 0 V	_	0.1	1.0	μΑ	
Drop-out voltage	V _{IN} -V _{OUT}	I _{OUT} = 150 mA (Note 5	_	180	230	mV	
Temperature coefficient	T _{CVO}	-40°C ≤ T _{opr} ≤ 85°C		_	100	_	ppm/°C
Output noise voltage	V _{NO}	$V_{IN} = V_{OUT} + 1 \text{ V, } I_{OUT} = 10 \text{ mA,} $ 10 Hz \leq f \leq 100 kHz, Ta = 25°C (Note 5)		_	35	_	μV _{rms}
Ripple rejection ratio	R.R.	$\begin{split} V_{IN} &= V_{OUT} + 1 \ V, \ I_{OUT} = 10 \ mA, \\ f &= 1 \ kHz, \ V_{Ripple} = 500 \ mV_{p-p}, \\ Ta &= 25^{\circ}C (Note 5) \end{split}$		_	73	_	dB
Load transient response	△Vout	I _{OUT} = 1 mA⇔150mA, C _{OUT} = 1.0 μF		_	±60	_	mV
Control voltage (ON)	V _{CT} (ON)			1.0	_	5.5	V
Control voltage (OFF)	V _{CT (OFF)}	_		0	_	0.4	V

Note 4: Stable state with fixed I_{OUT} condition

Note 5: The 2.5 V output product

Note 6: All charaterisites of over 4.5V output products are measured at V_{IN} = V_{OUT} + 0.5 V conditions.

Drop-out voltage

 $(I_{OUT} = 150 \text{ mA}, C_{IN} = 0.1 \mu\text{F}, C_{OUT} = 1.0 \mu\text{F}, T_j = 25^{\circ}\text{C})$

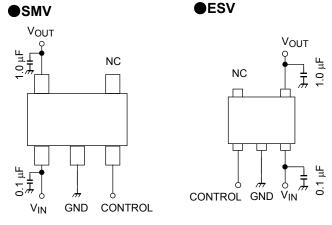
Output voltages	Symbol	Min	Тур.	Max	Unit
1.0 V, 1.05 V		_	510	770	
1.1 V, 1.15 V		_	440	670	
1.2 V, 1.25 V		_	380	570	
1.3 V	V _{IN} -V _{OUT}	_	350	470	
1.4 V		_	310	420	mV
1.5 V ≤ V _{OUT} < 1.8 V		_	290	390	
1.8 V ≤ V _{OUT} < 2.5 V		_	230	310	
2.5 V ≤ V _{OUT} < 3.0 V		_	180	230	
3.0 V ≤ V _{OUT} ≤ 5.0 V		_	150	200	

4



Application Note

1. Recommended Application Circuit



CONTROL pin connection	Operation	
HIGH	ON	
LOW	OFF	
OPEN	OFF	

The figure above shows the recommended configuration for using a Low-Dropout regulator. Insert a capacitor at V_{OUT} and V_{IN} pins for stable input/output operation. (Ceramic capacitors can be used).

2. Power Dissipation

Both unit and board-mounted power dissipation ratings for TCR2EF series and TCR2EE series are available in the Absolute Maximum Ratings table.

5

Power dissipation is measured on the board shown below.

Testing Board of Thermal Resistance

SMV ESV

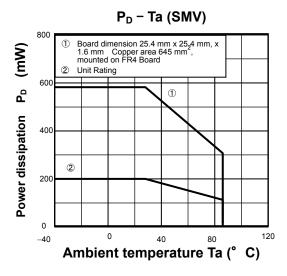
*Board material: FR4 board Board dimension: 25.4 mm \times 25.4 mm \times 1.6 mm

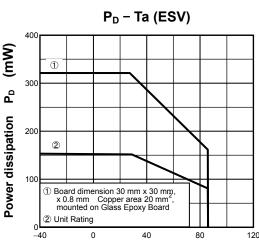
Copper area: 645 mm²

*Board material: FR4

Board dimension: 30 mm \times 30 mm \times 0.8 mm

Copper area: 20 mm²





Ambient temperature Ta (°C)

Attention in Use

Output Capacitors

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommend the ESR of ceramic capacitor is under 10 Ω .

Mounting

The long distance between IC and output capacitor might affect phase assurance by impedance in wire and inductor. For stable power supply, output capacitor need to mount near IC as much as possible. Also VIN and GND pattern need to be large and make the wire impedance small as possible.

Permissible Loss

Please have enough design patterns for expected maximum permissible loss. And under consideration of surrounding temperature, input voltage, and output current etc, we recommend proper dissipation ratings for maximum permissible loss; in general maximum dissipation rating is 70 to 80 percent.

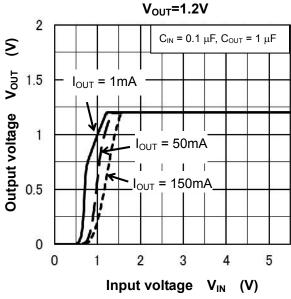
Overcurrent Protection Circuit

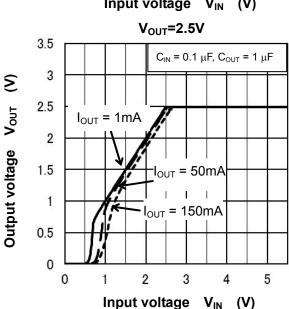
Overcurrent protection circuit is designed in these products, but this does not assure for the suppression of uprising device operation. If output pins and GND pins are shorted out, these products might be break down.

In use of these products, please read through and understand dissipation idea for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommend inserting failsafe system into the design.

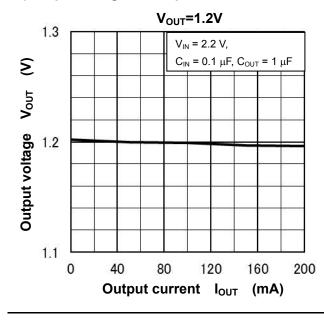
Representative Typical Characteristics

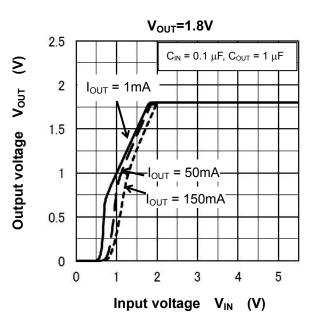
1) Output Voltage vs. Input Voltage

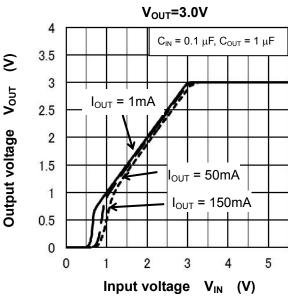


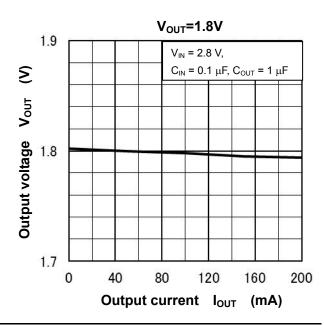


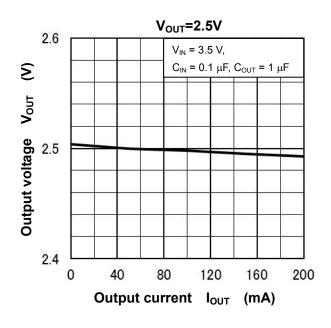
2) Output Voltage vs. Output Current

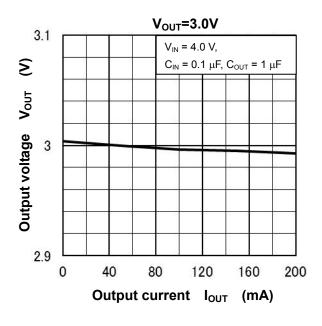




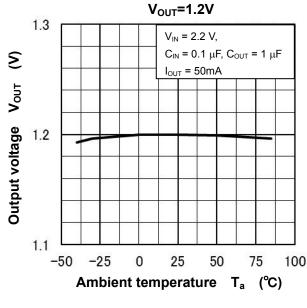


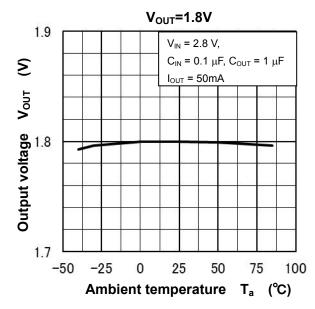


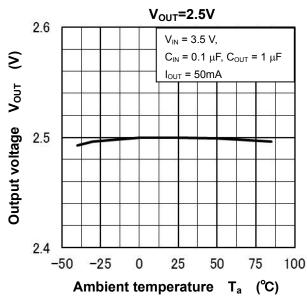


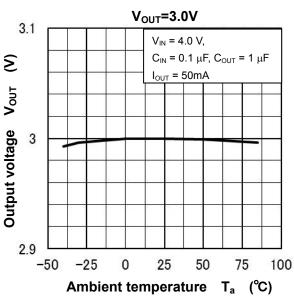


3) Output Voltage vs. Ambient Temperature

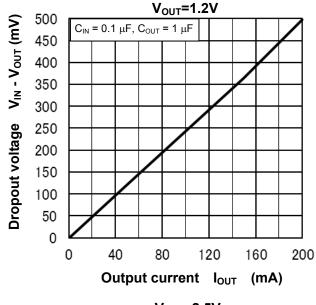


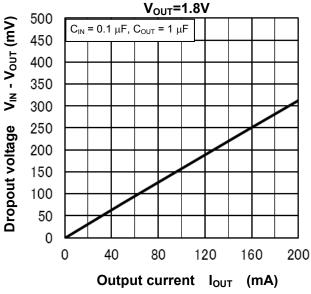


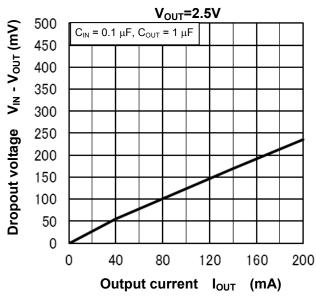


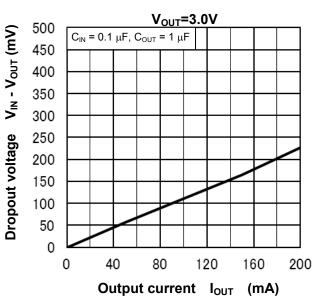


4) Dropout Voltage vs. Output Current

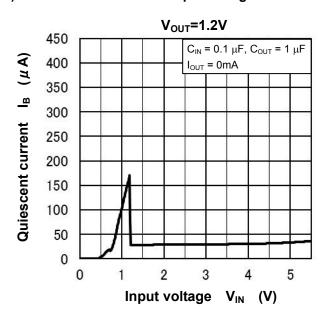


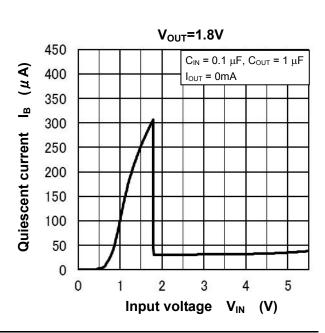




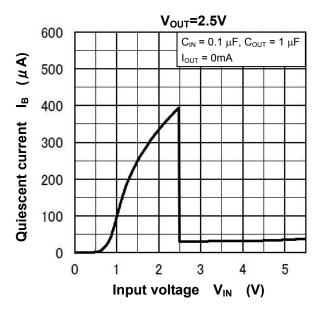


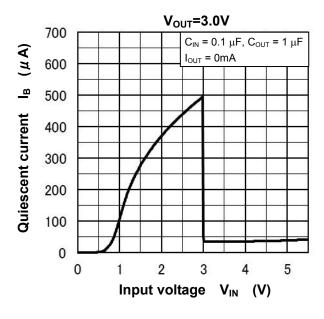
5) Quiescent Current vs. Input Voltage



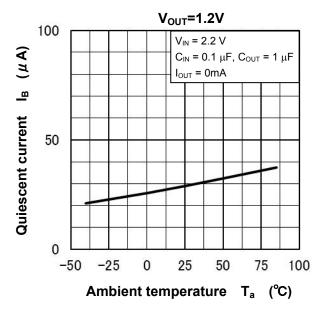


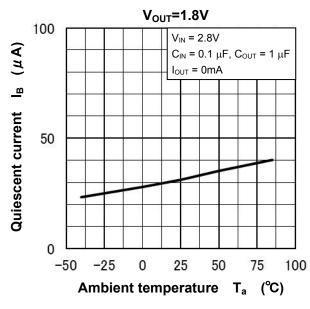
9

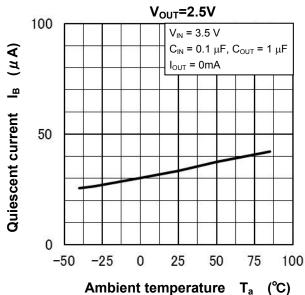


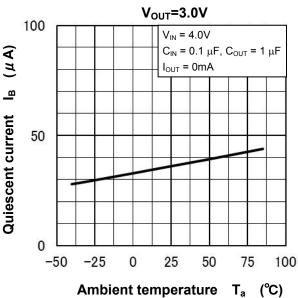


6) Quiescent Current vs. Ambient Temperature

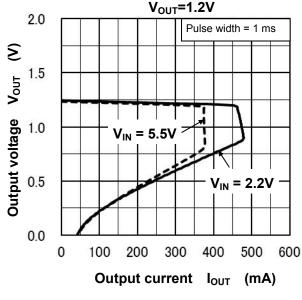


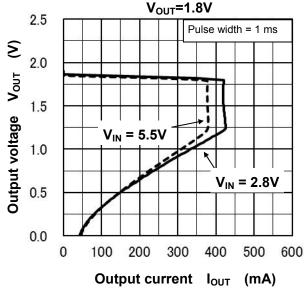


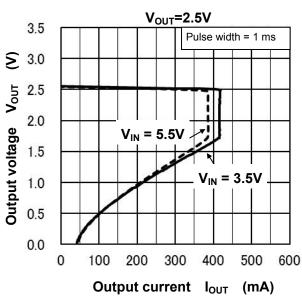


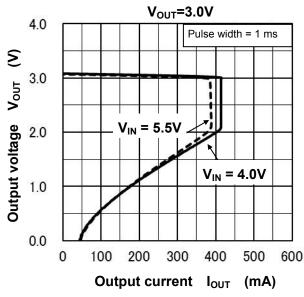


7) Output Voltage vs. Output Current

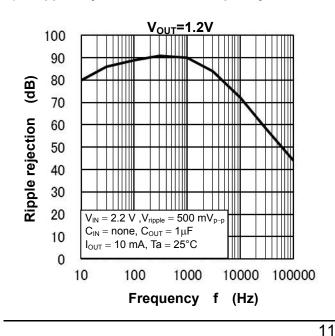


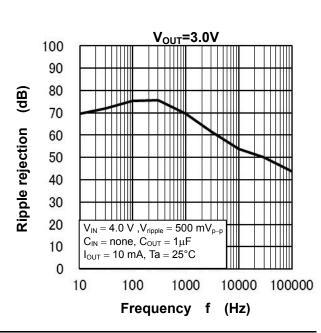




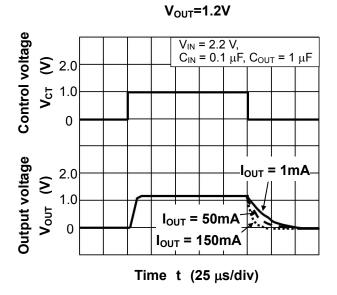


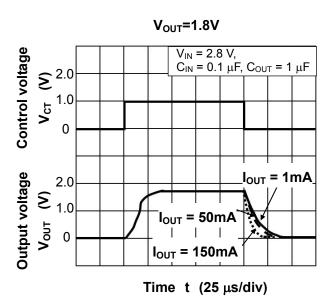
8) Ripple Rejection Ratio vs. Frequency

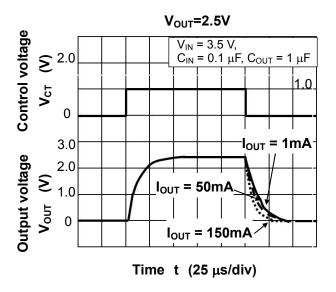


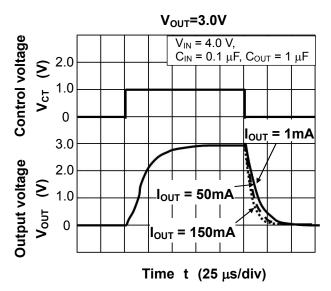


9) Control Transient Response

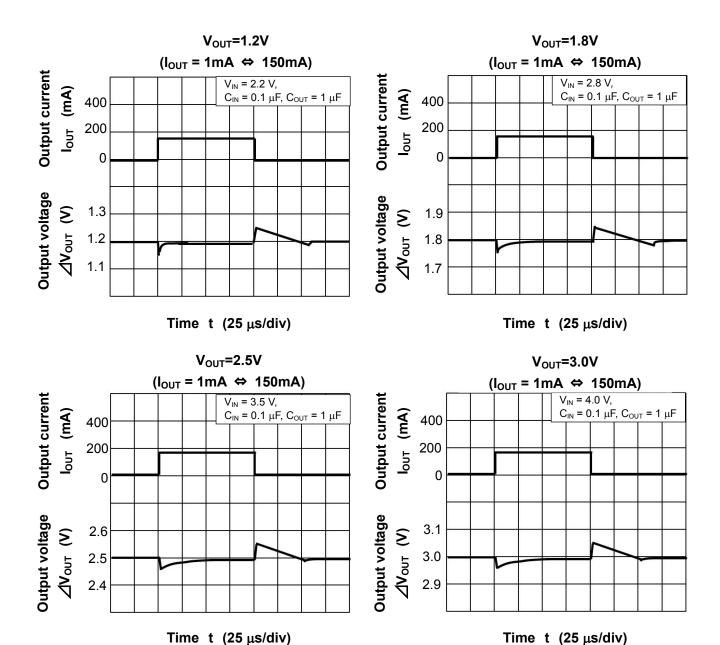








10) Control Transient Response

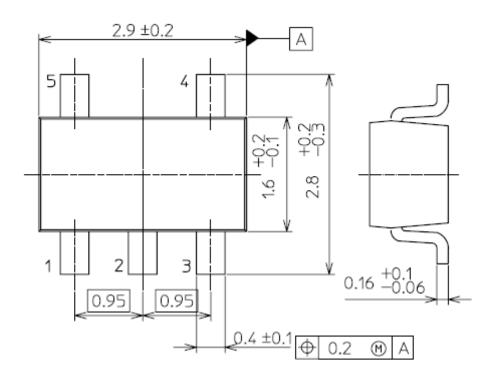


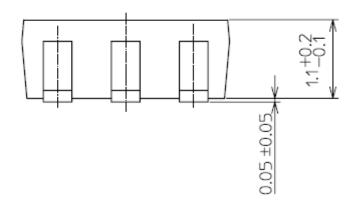
Unit: mm



Package Dimensions

SMV (SOT-25)(SC-74A)

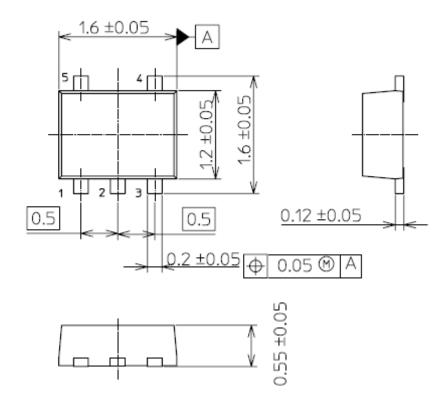


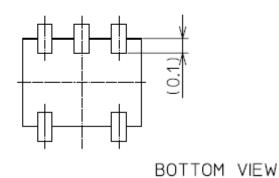


Weight: 16 mg (typ.)

Package Dimensions

ESV (SOT-553) Unit: mm





15

Weight: 3.0 mg (typ.)



RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
 EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH
 MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
 ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without
 limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for
 automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions,
 safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. IF YOU USE
 PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your
 TOSHIBA sales representative.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
 applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
 FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY
 WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR
 LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND
 LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO
 SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS
 FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without
 limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile
 technology products (mass destruction weapons). Product and related software and technology may be controlled under the
 applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the
 U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited
 except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
 Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES
 OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.